

# NCV7428

## System Basis Chip with Integrated LIN and Voltage Regulator

### Description

NCV7428 is a System Basis Chip (SBC) integrating functions typically found in automotive Electronic Control Units (ECUs). NCV7428 provides and monitors the low-voltage power supply for the application microcontroller and other loads and includes a LIN transceiver.

### Features

- Control Logic
  - ◆ Ensures safe power-up sequence and the correct reaction to different supply conditions
  - ◆ Controls mode transitions including the power management and bus wakeup treatment
  - ◆ Generates reset
- 3.3 V or 5 V  $V_{OUT}$  Supply depending on the Version from a Low-drop Voltage Regulator
  - ◆ Can deliver up to 70 mA with accuracy of  $\pm 2\%$
  - ◆ Supplies typically the ECU's microcontroller
  - ◆ Undervoltage detector with a reset output to the supplied microcontroller
- LIN Transceiver
  - ◆ LIN2.x and J2602 compliant
  - ◆ TxD dominant timeout protection
  - ◆ Transceiver mode controlled by dedicated input pin
- Protection and Monitoring Functions
  - ◆ Thermal shutdown protection
  - ◆ Load dump protection (45 V)
  - ◆ LIN Bus pin protected against transients in an automotive environment
  - ◆ ESD protection level for LIN and  $V_S > \pm 8$  kV
- These are Pb-Free Devices

### Quality

- NCV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable

### Typical Applications

- Automotive
- Industrial Networks



ON Semiconductor®

<http://onsemi.com>

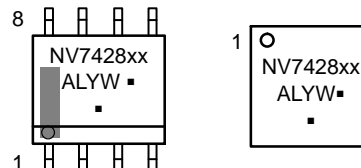


SOIC-8  
D SUFFIX  
CASE 751AZ



DFN8  
MW SUFFIX  
CASE 506BW

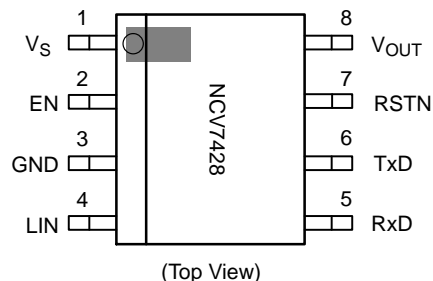
### MARKING DIAGRAMS



A = Assembly Location  
L = Wafer Lot  
Y = Year  
W = Work Week  
■ = Pb-Free Package

(Note: Microdot may be in either location)

### PIN ASSIGNMENT



### ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 16 of this data sheet.

This document contains information on some products that are still under development. ON Semiconductor reserves the right to change or discontinue these products without notice.

# NCV7428

## Block Diagram

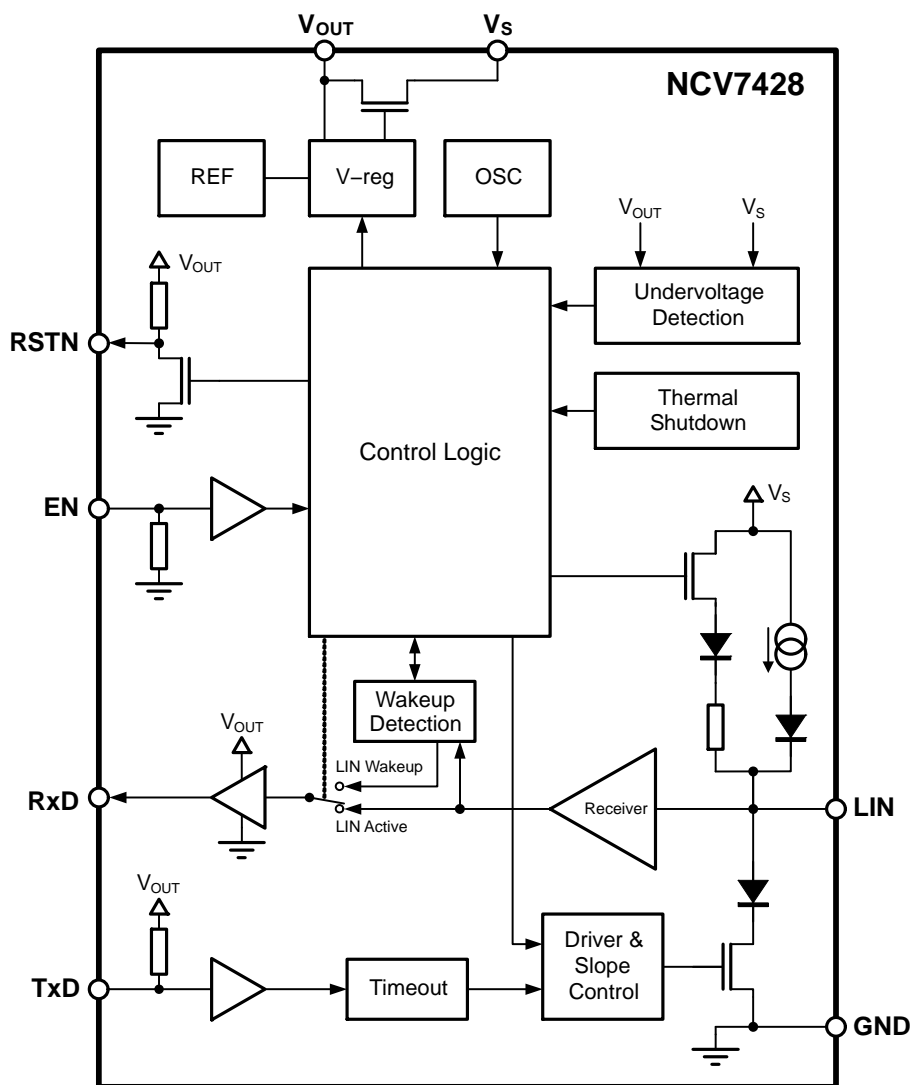


Figure 1. Block Diagram

## Pin Description

Table 1. PIN DESCRIPTION

Pin Number	Pin Name	Pin Type	Pin Function
1	V <sub>S</sub>	Battery supply input	Principle power supply of the device
2	EN	LV LIN enable input; internal pull-down	Input of the LIN block enable signal
3	GND	Ground connection	Ground connection
4	LIN	LIN bus interface	LIN bus line
5	RxD	LV digital output; push-pull	Output of data received on LIN bus
6	TxD	LV digital input; internal pull-up	Input of the data to be transmitted from LIN bus
7	RSTN	LV digital output; open drain; internal pull-up	System reset
8	V <sub>OUT</sub>	LV supply output	Output of the 5 V or 3.3 V/70 mA low-drop regulator (for the MCU)

NOTE: (LV = Low Voltage; HV = High Voltage)

## Application Information

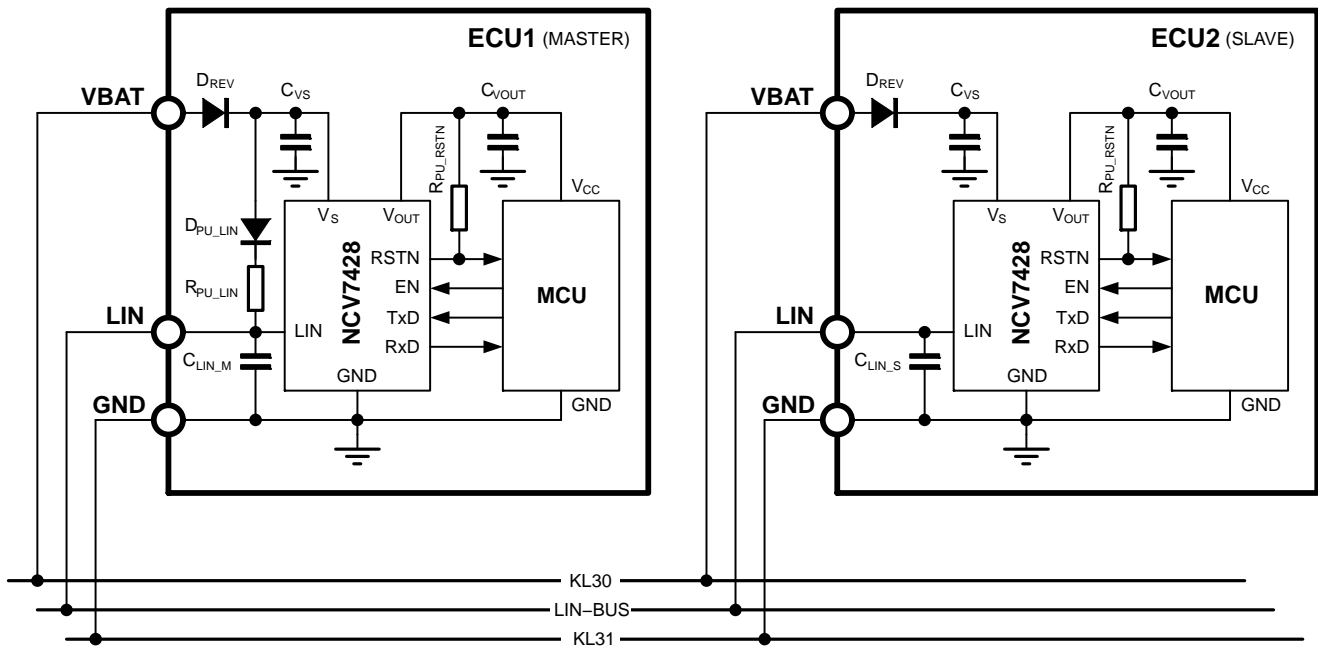


Figure 2. Example Application Diagram

### External Components

Overview of external components from application schematic in Figure 2 is given in Table 2 together with their recommended or required values.

Table 2. EXTERNAL COMPONENTS OVERVIEW

Component Name	Description	Value	Note
D <sub>REV</sub>	Reverse polarity protection diode	parameters application-specific; e.g. 0.5 A / 50 V	required values and types depend on the V <sub>OUT</sub> load and the application needs
C <sub>VS</sub>	Filtering capacitor for the battery input	recommended >100 nF ceramic	
C <sub>VOUT</sub>	Voltage regulator output filtering and stabilization capacitor	> 1.8 $\mu$ F, For the details of ESR range see Application note	
D <sub>PU_LIN</sub>	Master node Pull-up diode on LIN line		required only for master LIN node
R <sub>PU_LIN</sub>	Master node Pull-up resistor on LIN line	1 k $\Omega$ nominal, $\geq$ 500 mW	
C <sub>LIN_M</sub>	Filtering capacitor on LIN line (Master node)	typically 1 nF	optional; is function of the entire LIN network
C <sub>LIN_S</sub>	Filtering capacitor on LIN line (Slave node)	typically 100 pF – 220 pF	optional; is function of the entire LIN network
R <sub>PU_RSTN</sub>	Pull-up resistor at RSTN pin	recommended 10 k $\Omega$ nominal	optional; depends on application needs

**Table 3. ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter	Min	Max	Units
$V_S$	Maximum DC voltage at $V_S$ pin	-0.3	45	V
$V_{OUT}$	Maximum voltage at $V_{OUT}$ pin	-0.3	6	V
$V_{LIN}$	Maximum voltage at LIN bus pin	-45	45	V
$V_{Dig\_IO\_inputs}$	Maximum voltage at digital input pins (TxD, EN)	-0.3	45	V
$V_{Dig\_IO\_outputs}$	Maximum voltage at digital output pins (RxD, RSTN)	-0.3	$V_{OUT}+0.3$	V
$T_J$	Junction temperature	-40	+170	°C
$V_{ESD}$	System ESD at pins $V_S$ , LIN as per IEC 61000-4-2: 330 $\Omega$ / 150 pF (Verified by external test house)	$\geq \pm 14$		kV
	Human body model at pins $V_S$ , LIN stressed towards GND with 1500 $\Omega$ / 100 pF	$\geq \pm 8$		kV
	Human body model at all pins as per JESD22-A114 / AEC-Q100-002	$\geq \pm 4$		kV
	Charge device model at all pins as per JESD22-C101 / AEC-Q100-011	$\geq \pm 500$		V
	Machine model; (200 pF; 0.75 $\mu$ H; 10 $\Omega$ ) as per JESD22-A115 / AEC-Q100-003	$\pm 200$		V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

**Table 4. OPERATING RANGES**

Symbol	Parameter	Min	Max	Units
$V_S$	$V_S$ operating voltage for parametric operation (Note 1)	5.5	28	V
	$V_S$ operating voltage for limited operation (Note 1)	4	28	V
$V_{OUT5}$	Regulated voltage at $V_{OUT}$ supply output for 5 V versions	4.9	5.1	V
$V_{OUT33}$	Regulated voltage at $V_{OUT}$ supply output for 3.3 V versions	3.234	3.366	V
$I_{VOUT}$	Current delivered by the $V_{OUT}$ regulator	70		mA
$V_{LIN}$	Operating voltage at LIN bus pin	0	$V_S$	V
$V_{Dig\_IO\_inputs}$	Operating voltage at digital input pins (TxD, EN)	0	5.5	V
$V_{Dig\_IO\_outputs}$	Operating voltage at digital output pins (RxD, RSTN)	0	$V_{OUT}$	V
$T_J$	Junction temperature	-40	+150	°C
$T_{AMB}$	Ambient temperature	-40	+125	°C

1. Below 5.5 V at  $V_S$  pin in normal mode, the bus will either stay recessive or comply with the voltage level specifications and transition time specifications as required by SAE J2602. It is ensured by the battery monitoring circuit. Above 28 V at  $V_S$  pin, LIN communication is operational (LIN pin toggling) but parameters cannot be guaranteed. For higher battery voltage operation above 28 V, LIN pull-up resistor must be selected large enough to avoid clamping of LIN pin by voltage drop over external pull-up resistor and LIN pin min current limitation. Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

**Table 5. THERMAL CHARACTERISTICS**

Symbol	Parameter	Conditions	Value	Unit
$R_{\theta JA\_1}$	Thermal Resistance Junction-to-Air, 1S0P PCB (Note 2)	Free air	125	K/W
$R_{\theta JA\_2}$	Thermal Resistance Junction-to-Air, 2S2P PCB (Note 3)	Free air	75	K/W

2. Test board according to EIA/JEDEC Standard JESD51-3, signal layer with 10% trace coverage  
3. Test board according to EIA/JEDEC Standard JESD51-7, signal layers with 10% trace coverage

## Definitions

The characteristics defined in this section are guaranteed within the operating ranges listed in Table 4, unless stated otherwise. All voltages are referenced to GND (Pin 3). Positive currents flow into the respective pin.

**Table 6. DC CHARACTERISTICS** ( $V_S = 5.5\text{ V}$  to  $28\text{ V}$ ;  $T_J = -40^\circ\text{C}$  to  $+150^\circ\text{C}$ ; Bus Load =  $500\ \Omega$  ( $V_S$  to LIN); unless otherwise specified. Typical values are given at  $V_S = 12\text{ V}$  and  $T_J = 25^\circ\text{C}$ , unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>SUPPLY MONITORING</b>						
$V_{S\_PORH}$	$V_S$ threshold for the power-up of the circuit	$V_S$ rising	3.3		4	V
$V_{S\_PORL}$	$V_S$ threshold for the Shutdown of the circuit	$V_S$ falling	2.2		3	V
$V_{OUT\_RES\_5}$	$V_{OUT}$ monitoring threshold NV7428-5	$V_{OUT}$ falling	4.55		4.75	V
$V_{OUT\_RES\_33}$	$V_{OUT}$ monitoring threshold NV7428-3	$V_{OUT}$ falling	2.97		3.135	V
$V_{OUT\_RES\_hys5}$	$V_{OUT}$ monitoring threshold hysteresis for NV7428-5			0.1		V
$V_{OUT\_RES\_hys33}$	$V_{OUT}$ monitoring threshold hysteresis for NV7428-3			0.06		V
<b>CURRENT CONSUMPTION</b>						
$I_{VS\_LIN\_Active\_rec}$	$V_S$ supply current	LIN Active, LIN bus recessive			1.8	mA
$I_{VS\_LIN\_Wakeup}$	$V_S$ supply current (Note 6)	Standby mode; LIN Wakeup, LIN bus recessive; $I_{V_{OUT}} = 0\text{ mA}$ $V_S = 13.5\text{ V}$ , $T_J < 105^\circ\text{C}$		25	40	$\mu\text{A}$
$I_{VS\_Sleep}$	$V_S$ supply current (Note 6)	Sleep mode; LIN Wakeup, LIN bus recessive; $V_{OUT}$ off, $V_{OUT} < 0.5\text{ V}$ $V_S = 13.5\text{ V}$ , $T_J < 105^\circ\text{C}$		12	25	$\mu\text{A}$
<b><math>V_{OUT}</math> REGULATOR</b>						
$V_{OUT\_5}$	$V_{OUT}$ regulator output voltage NV7428-5	$V_{OUT}$ regulator active, $0 < I_{V_{OUT}} < 70\text{ mA}$ , Static regulation, $V_S = 5.5\text{ V}$ to $28\text{ V}$	4.9	5	5.1	V
$V_{OUT\_33}$	$V_{OUT}$ regulator output voltage NV7428-3	$V_{OUT}$ regulator active, $0 < I_{V_{OUT}} < 70\text{ mA}$ , Static regulation, $V_S = 4.5\text{ V}$ to $28\text{ V}$	3.234	3.3	3.366	V
$I_{LIM\_VOUT}$	$V_{OUT}$ current limitation	$V_{OUT}$ regulator active; current flowing to $V_{OUT}$ load	70	120	350	mA
$V_{DROP\_VOUT}$	Drop-out voltage between $V_S$ and $V_{OUT}$	$5.5\text{ V} < V_S < 40\text{ V}$ ; $I_{V_{OUT}} = 70\text{ mA}$			0.55	V
$I_{SINK\_VOUT}$	$V_{OUT}$ sink current	$V_{OUT}$ regulator active, current flowing into the $V_{OUT}$ pin	100	240	400	$\mu\text{A}$
$C_{VOUT}$	$V_{OUT}$ regulator filtering capacitance (Note 5)	Equivalent series resistance $< 7\ \Omega$	1.8	10		$\mu\text{F}$
<b>LIN TRANSMITTER</b>						
$V_{LIN\_dom\_LoSup}$	LIN dominant output voltage	$TxD = \text{Low}$ ; $V_S = 7.3\text{ V}$			1.2	V
$V_{LIN\_dom\_HiSup}$	LIN dominant output voltage	$TxD = \text{Low}$ ; $V_S = 18\text{ V}$			2.0	V
$V_{LIN\_REC}$	LIN recessive output voltage	$TxD = \text{High}$ ; $I_{LIN} = 10\ \mu\text{A}$ (Note 4)	$V_S - 1.5$		$V_S$	V
$I_{LIN\_lim}$	Short circuit current limitation	$V_{LIN} = V_S = 18\text{ V}$	40		200	mA
$R_{slave}$	Internal Pull-up Resistance	LIN Normal or Receive-only mode	20	33	47	k $\Omega$
$C_{LIN}$	Capacitance at pin LIN (Note 6)			20	30	pF

- The voltage drop in Normal mode between LIN and  $V_S$  pin is the sum of the diode drop and the drop at serial pull-up resistor. The drop at the switch is negligible. See Figure 1.
- In parallel with this capacitor any other capacitor can be placed with no limit to ESR and capacitance value
- Values based on design and characterization. Not tested in production.

# NCV7428

**Table 6. DC CHARACTERISTICS** ( $V_S = 5.5\text{ V to }28\text{ V}$ ;  $T_J = -40^\circ\text{C to }+150^\circ\text{C}$ ; Bus Load =  $500\ \Omega$  ( $V_S$  to LIN); unless otherwise specified. Typical values are given at  $V_S = 12\text{ V}$  and  $T_J = 25^\circ\text{C}$ , unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
--------	-----------	------------	-----	-----	-----	------

## LIN Receiver

$V_{bus\_dom}$	Bus voltage for Dominant state				0.4	$V_S$
$V_{bus\_rec}$	Bus voltage for Recessive state		0.6			$V_S$
$V_{rec\_dom}$	Receiver threshold	LIN bus going from Recessive to Dominant	0.4		0.6	$V_S$
$V_{rec\_rec}$	Receiver threshold	LIN bus going from Dominant to Recessive	0.4		0.6	$V_S$
$V_{rec\_cnt}$	Receiver center voltage	$(V_{rec\_dom} + V_{rec\_rec})/2$	0.475		0.525	$V_S$
$V_{rec\_hys}$	Receiver hysteresis	$V_{rec\_rec} - V_{rec\_dom}$	0.05		0.175	$V_S$
$I_{LIN\_off\_dom}$	LIN output current, Bus in dominant state	LIN Active Mode, Driver Off; $V_S = 12\text{ V}$ , $V_{LIN} = 0\text{ V}$	-1			mA
$I_{LIN\_off\_dom\_wake}$	LIN output current, Bus in dominant state	LIN Wakeup Mode; $V_S = 12\text{ V}$ , $V_{LIN} = 0\text{ V}$	-20	-15	-2	$\mu\text{A}$
$I_{LIN\_off\_rec}$	LIN output current, Bus in recessive state	Driver Off; $V_S < 18\text{ V}$ ; $V_S < V_{LIN} < 18\text{ V}$			1	$\mu\text{A}$
$I_{LIN\_no\_GND}$	LIN current with missing GND	$V_S = GND = 12\text{ V}$ ; $0 < V_{LIN} < 18\text{ V}$	-1		1	mA
$I_{LIN\_no\_VBB}$	LIN current with missing $V_S$	$V_S = GND = 0\text{ V}$ ; $0 < V_{LIN} < 18\text{ V}$			5	$\mu\text{A}$

## PIN EN

$V_{IL\_EN}$	Low-level input voltage		-0.3		0.8	V
$V_{IH\_EN}$	High-level input voltage		2		5.5	V
$R_{pulldown\_EN}$	Pull-down resistance to GND		55	100	185	k $\Omega$

## PIN TxD

$V_{IL\_TxD}$	Low-level input voltage		-0.3		0.8	V
$V_{IH\_TxD}$	High-level input voltage		2		5.5	V
$R_{pullup\_TxD}$	Pull-up resistance to $V_{OUT}$		55	100	185	k $\Omega$
$I_{leak\_TxD}$	Leakage current	$V_{TxD} = V_{OUT} = 5.5\text{ V}$	-1	0	1	$\mu\text{A}$

## PIN RSTN

$I_{OL\_RSTN}$	Low-level output driving current	$V_S = 4\text{ V to }28\text{ V}$ ; $V_{RSTN} = 0.4\text{ V}$	4		30	mA
$V_{OL\_RSTN}$	Low-level output voltage	$V_S = 2\text{ V to }4\text{ V}$ ; $V_{OUT} = 0\text{ V to }5.5\text{ V}$ ; $I_{RSTN} = 100\ \mu\text{A}$			0.1	$V_{OUT}$
		$V_S < 2\text{ V}$ ; $V_{OUT} = 1\text{ V to }5.5\text{ V}$ ; $I_{RSTN} = 100\ \mu\text{A}$			0.1	$V_{OUT}$
$R_{pullup\_RSTN}$	Pull-up resistance to $V_{OUT}$		55	100	185	k $\Omega$
$V_{S\_DigOut\_Low}$	$V_S$ level guaranteeing Low level at RSTN pin	Shutdown mode; Low level guaranteed for $V_S > V_{S\_DigOut\_Low}$			2	V

## PIN RxD

$I_{OL\_RxD}$	Low-level output driving current	$V_{RxD} = 0.4\text{ V}$	0.4			mA
$I_{OH\_RxD}$	High-level output driving current	$V_{RxD} = V_{OUT} - 0.4\text{ V}$			-0.16	mA

## THERMAL SHUTDOWN

$T_{J\_SD}$	Junction temperature for thermal Shutdown		160	180	200	$^\circ\text{C}$
$T_{J\_SD\_hys}$	Thermal Shutdown hysteresis			10		$^\circ\text{C}$

- The voltage drop in Normal mode between LIN and  $V_S$  pin is the sum of the diode drop and the drop at serial pull-up resistor. The drop at the switch is negligible. See Figure 1.
- In parallel with this capacitor any other capacitor can be placed with no limit to ESR and capacitance value
- Values based on design and characterization. Not tested in production.

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

**Table 7. AC CHARACTERISTICS** ( $V_S = 5.5\text{ V to }28\text{ V}$ ;  $T_J = -40^\circ\text{C to }+150^\circ\text{C}$ ; unless otherwise specified. For the transmitter parameters, the following bus loads are considered: L1 = 1 k $\Omega$  / 1 nF; L2 = 660  $\Omega$  / 6.8 nF; L3 = 500  $\Omega$  / 10 nF)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>LIN TRANSMITTER</b>						
D1	Duty Cycle 1 = $t_{\text{BUS\_REC(min)}} / (2 \times t_{\text{BIT}})$	$\text{TH}_{\text{REC(max)}} = 0.744 \times V_S$ $\text{TH}_{\text{DOM(max)}} = 0.581 \times V_S$ $t_{\text{BIT}} = 50\text{ }\mu\text{s}$ $V_S = 7\text{ V to }18\text{ V}$	0.396		0.5	
D2	Duty Cycle 2 = $t_{\text{BUS\_REC(max)}} / (2 \times t_{\text{BIT}})$	$\text{TH}_{\text{REC(min)}} = 0.422 \times V_S$ $\text{TH}_{\text{DOM(min)}} = 0.284 \times V_S$ $t_{\text{BIT}} = 50\text{ }\mu\text{s}$ $V_S = 7.6\text{ V to }18\text{ V}$	0.5		0.581	
D3	Duty Cycle 3 = $t_{\text{BUS\_REC(min)}} / (2 \times t_{\text{BIT}})$	$\text{TH}_{\text{REC(max)}} = 0.778 \times V_S$ $\text{TH}_{\text{DOM(max)}} = 0.616 \times V_S$ $t_{\text{BIT}} = 96\text{ }\mu\text{s}$ $V_S = 7\text{ V to }18\text{ V}$	0.417		0.5	
D4	Duty Cycle 4 = $t_{\text{BUS\_REC(max)}} / (2 \times t_{\text{BIT}})$	$\text{TH}_{\text{REC(min)}} = 0.389 \times V_S$ $\text{TH}_{\text{DOM(min)}} = 0.251 \times V_S$ $t_{\text{BIT}} = 96\text{ }\mu\text{s}$ $V_S = 7.6\text{ V to }18\text{ V}$	0.5		0.590	
$t_{\text{fallNS}}$	LIN falling edge normal slope	Normal Mode; $V_S = 12\text{ V}$			22.5	$\mu\text{s}$
$t_{\text{riseNS}}$	LIN rising edge normal slope	Normal Mode; $V_S = 12\text{ V}$			22.5	$\mu\text{s}$
$t_{\text{symNS}}$	LIN slope symmetry normal slope	Normal Mode; $V_S = 12\text{ V}$	-4	0	4	$\mu\text{s}$
$t_{\text{fallLS}}$	LIN falling edge low slope (Note 8)	Normal Mode; $V_S = 12\text{ V}$			45	$\mu\text{s}$
$t_{\text{riseLS}}$	LIN rising edge low slope (Note 8)	Normal Mode; $V_S = 12\text{ V}$			45	$\mu\text{s}$
$t_{\text{tx\_prop\_down}}$	Propagation Delay of TxD to LIN. TxD high to low	(Note 7)			10	$\mu\text{s}$
$t_{\text{tx\_prop\_up}}$	Propagation Delay of TxD to LIN. TxD low to high	(Note 7)			10	$\mu\text{s}$
$t_{\text{TxD\_timeout}}$	TxD dominant timeout	TxD = Low; LIN dominant timeout enabled	7	13	24	ms
<b>LIN RECEIVER</b>						
$t_{\text{rec\_prop\_down}}$	Propagation delay of receiver falling edge		0.1		6	$\mu\text{s}$
$t_{\text{rec\_prop\_up}}$	Propagation delay of receiver rising edge		0.1		6	$\mu\text{s}$
$t_{\text{rec\_sym}}$	Propagation delay symmetry	$T_{\text{rec\_prop\_down}} -$ $T_{\text{rec\_prop\_up}}$	-2		2	$\mu\text{s}$
$t_{\text{LIN\_wake}}$	Dominant duration for wakeup	LIN in wakeup mode	30	80	150	$\mu\text{s}$
<b>MODE TRANSITIONS AND TIMEOUTS</b>						
$t_{\text{synch}}$	Input signal synchronization delay		5	15	40	$\mu\text{s}$
$t_{\text{synch\_action}}$	Delay from the asynchronous input pin change to the system state change		11	25	55	$\mu\text{s}$
$t_{\text{modsel\_set}}$	Low power mode selection delay		17	30	55	$\mu\text{s}$
$t_{\text{reset}}$	RSTN pulse extension		2	5	10	ms
$t_{\text{VOUT\_RES\_filt}}$	Undervoltage detection filter time		11	25	55	$\mu\text{s}$

7. Values based on design and characterization. Not tested in production.

8. For low slope versions only (NV7428L5 and NV7428L3)

## Functional Description

**VS Supply Input**

$V_S$  pin of NCV7428 is typically connected to the car battery through a reverse-protection diode and can be exposed to all relevant automotive disturbances (ISO7637 pulses, system ESD ...).  $V_S$  supplies mainly the integrated LIN transceiver. Filtering capacitors should be connected between  $V_S$  and GND.

During power-up of the battery supply,  $V_S$  pin must reach  $V_{S\_PORH}$  level in order for the circuit to become functional – the internal state machine is initiated and the  $V_{OUT}$  regulator is activated. The circuit remains functional until  $V_S$  falls back below  $V_{S\_PORL}$  level, when the device enters the Shutdown mode.

**VOUT Low-drop Voltage Regulator**

The application low-voltage supply is provided by an integrated low-drop voltage regulator delivering a 5 V or 3.3 V output  $V_{OUT}$ . It is able to deliver up to 70 mA with given precision and is primarily intended to supply the application microcontroller unit (MCU) and related 5 V or 3.3 V loads (e.g. its own MCU-related digital inputs/outputs). An external capacitor needs to be connected on  $V_{OUT}$  pin in order to ensure the regulator's stability and to filter the disturbances caused by the connected loads.

All low-voltage digital pins are related to  $V_{OUT}$ .

**LIN Transceiver**

NCV7428 integrates on-chip LIN transceiver interface between physical LIN bus and the LIN protocol controller.

This LIN physical layer is compatible to LIN2.x and J2602 specifications.

NCV7428 LIN2.2 compliant physical layer can be combined on the network with all previous LIN physical layers.

NCV7428 LIN transceiver consists of a transmitter, receiver and wakeup detector. The LIN transceiver can be connected to the bus line via LIN pin, and to the digital control through pins TxD and RxD. The functional mode of the LIN transceiver depends on the operating mode and on EN pin state – see Figure 3. The LIN transceiver is supplied directly from the  $V_S$  pin.

**LIN Operating Modes**

In **LIN Active mode** the transceiver can transmit and receive data via LIN bus with speed up to 20 kBaud for normal slope mode and 10 kBaud/s for low slope version. The transmit data stream of the LIN protocol is present on the TxD pin and converted by the transmitter into a LIN bus signal with controlled slew rate to minimize EMC emission. The receiver consists of the comparator that has a threshold with hysteresis in respect to the supply voltage and an input filter to remove bus noise. The LIN output is pulled HIGH via an internal pull-up resistor (typ. 30 k $\Omega$ ). For master applications, it is needed to put an external resistor (typ. 1 k $\Omega$ ) with a serial diode between LIN and  $V_S$ . The mode selection is done by EN = High.

The transmission is only initiated with the TxD falling edge in LIN Active mode. Entering this mode with TxD already Low will not lead to transmitting bus Dominant signal.

When leaving Normal mode (EN pin falling edge), the transmitter is deactivated immediately.

The **LIN Wakeup mode** can be entered if the EN pin is Low. The LIN receiver stays active to be able to detect a remote wake-up via bus. The LIN transmitter is disabled and the slave internal termination resistor of 30 k $\Omega$  between LIN and  $V_S$  is disconnected in order to minimize current consumption. Only a pull-up current source between  $V_S$  and LIN is active. The valid LIN wakeup event causes driving RxD Low until EN pin is pulled High.

A Wakeup pattern that is initiated in LIN Active mode and ends in LIN Wakeup mode is also considered a valid Wakeup event.

The LIN Wakeup mode is also forced if the device enters to the Sleep operating mode.

The **LIN Off mode** provides extreme low current consumption, LIN transceiver is fully deactivated. Pin RxD stays High (as long as  $V_{OUT}$  is provided) and logical level on TxD is ignored.

The bus pin is internally pulled to  $V_S$  with a current source (thus limiting  $V_S$  consumption in case of a permanent LIN short to GND).

This mode is entered when NCV7428 is in Shutdown mode ( $V_S < V_{S\_PORL}$ ) or in Thermal Shutdown mode ( $T_J > T_{J\_SD}$ ).



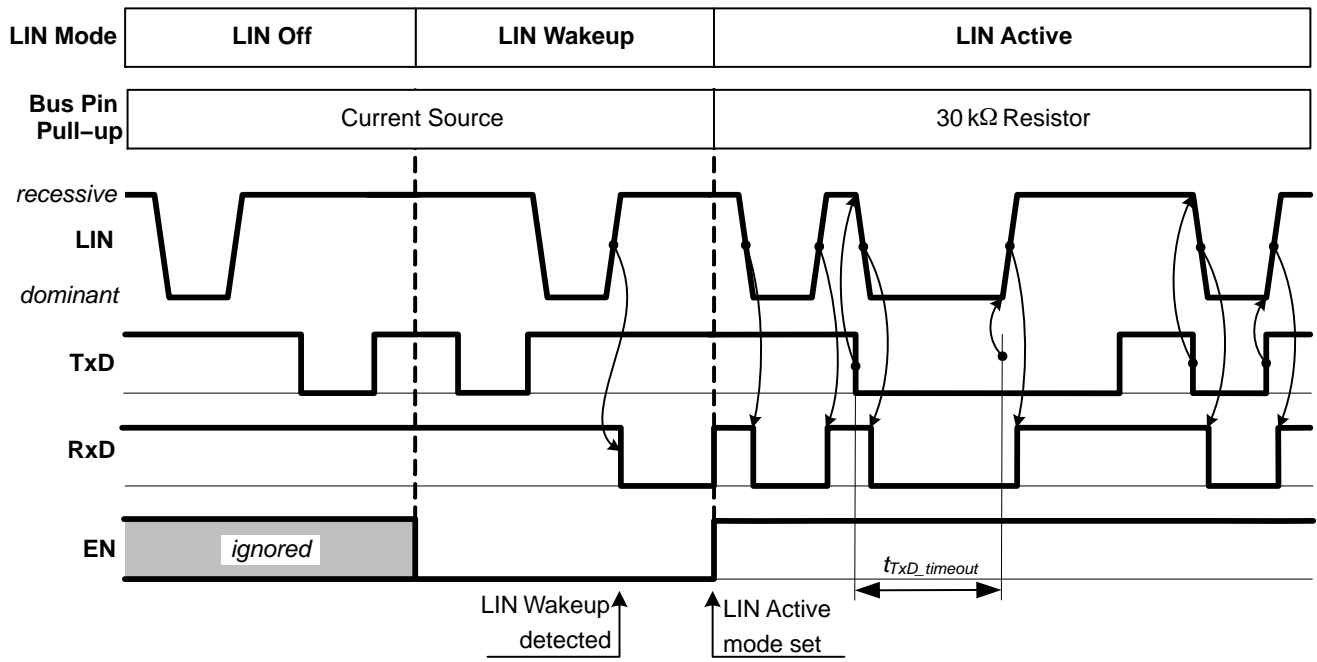


Figure 3. LIN Modes

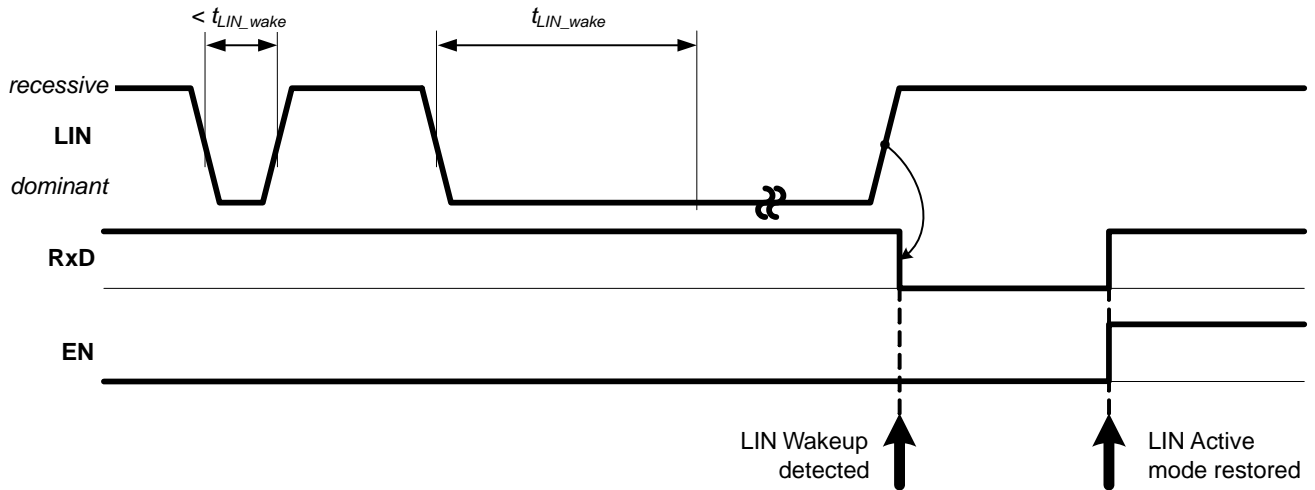


Figure 4. LIN Wakeup Detection

## Operating Modes

The principal operating modes of NCV7428 are shown in Figure 5 and described in the following paragraphs.

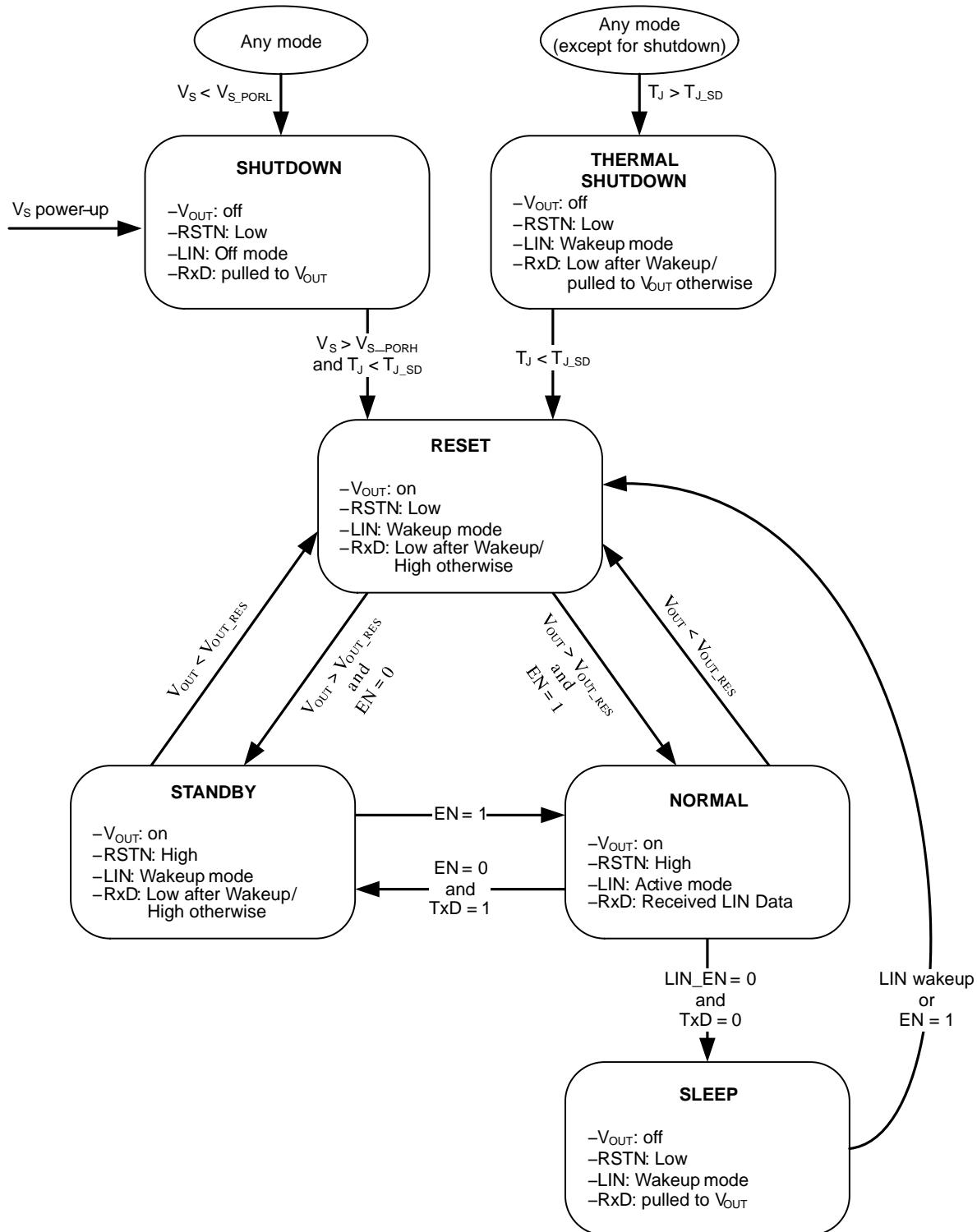


Figure 5. Operating Modes

### Shutdown Mode

The Shutdown mode is a passive state, in which all NCV7428 resources are inactive. The Shutdown mode provides a defined starting point for the circuit in case of supply undervoltage, thermal Shutdown or the first supply connection.

On-chip power-supply  $V_{OUT}$  is switched off and the LIN pin remains passive so that it does not disturb the communication of other nodes connected to the LIN bus. RxD pin stays pulled to  $V_{OUT}$ . No wakeups can be detected.

RSTN pin is forced Low – RSTN Low level is guaranteed for  $V_S$  supply above  $V_{S\_DigOut\_Low}$ .

The Shutdown mode is entered asynchronously whenever the  $V_S$  level falls below the power-on-reset level  $V_{S\_PORL}$ .

The Shutdown mode is left only when the  $V_S$  supply exceeds the high power-on-reset level  $V_{S\_PORH}$  while junction temperature is below  $T_{J\_SD}$ . When exiting the Shutdown mode, NCV7428 always enters the Reset mode.

### RESET Mode

The Reset mode is a transient mode providing a defined RSTN pulse for the application microcontroller.

$V_{OUT}$  supply is kept active. The LIN pin is passive so that it does not disturb the communication of other nodes connected to the bus. RxD pin is High if no wakeup was detected, RxD Low level indicates pending LIN wakeup. Pin RSTN is forced Low.

Reset mode will be entered as a consequence of one of the following events:

- Shutdown mode is exited
- Thermal Shutdown mode is exited
- $V_{OUT}$  voltage falls below  $V_{OUT\_RES}$  level
- LIN wakeup or EN = High was detected in Sleep mode

Normally, the Reset mode is left when  $V_{OUT}$  voltage is above  $V_{OUT\_RES}$  threshold and defined time  $t_{reset}$  elapses. The RSTN pin is internally released to High and the chip then goes to the Normal or Standby mode, depending on EN state.

### Normal Mode

Normal mode is entered from Standby mode after a host request – driving EN pin High (Figure 9), or if EN pin is High when leaving Reset mode –  $t_{reset}$  time elapsed (Figure 8).

LIN transceiver is in Active mode.  $V_{OUT}$  is kept on. Pin RSTN remains High.

### Standby Mode

Standby mode is entered from Normal mode after host request – EN pin falling edge followed by TxD pin High. TxD is sampled  $t_{synch} + t_{modesel}$  after EN edge (Figure 9). Standby mode is also entered if EN pin is Low when leaving Reset mode –  $t_{reset}$  time elapsed (Figure 7).

LIN transceiver is in Wakeup mode – RxD pin is latched Low after valid Wakeup recognition until Normal mode is requested.  $V_{OUT}$  is kept active. Pin RSTN remains High.

### Sleep Mode

Sleep mode can be only entered from Normal mode after a host request – EN pin falling edge followed by TxD pin Low. TxD is sampled  $t_{synch} + t_{modesel}$  after EN pin edge (Figure 10).

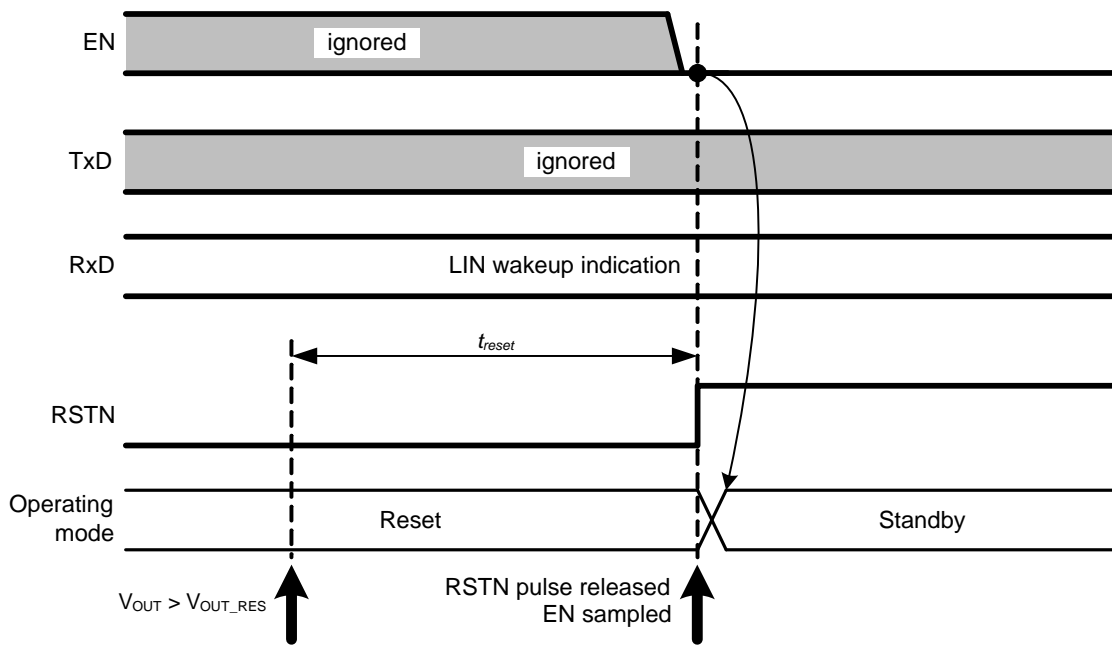
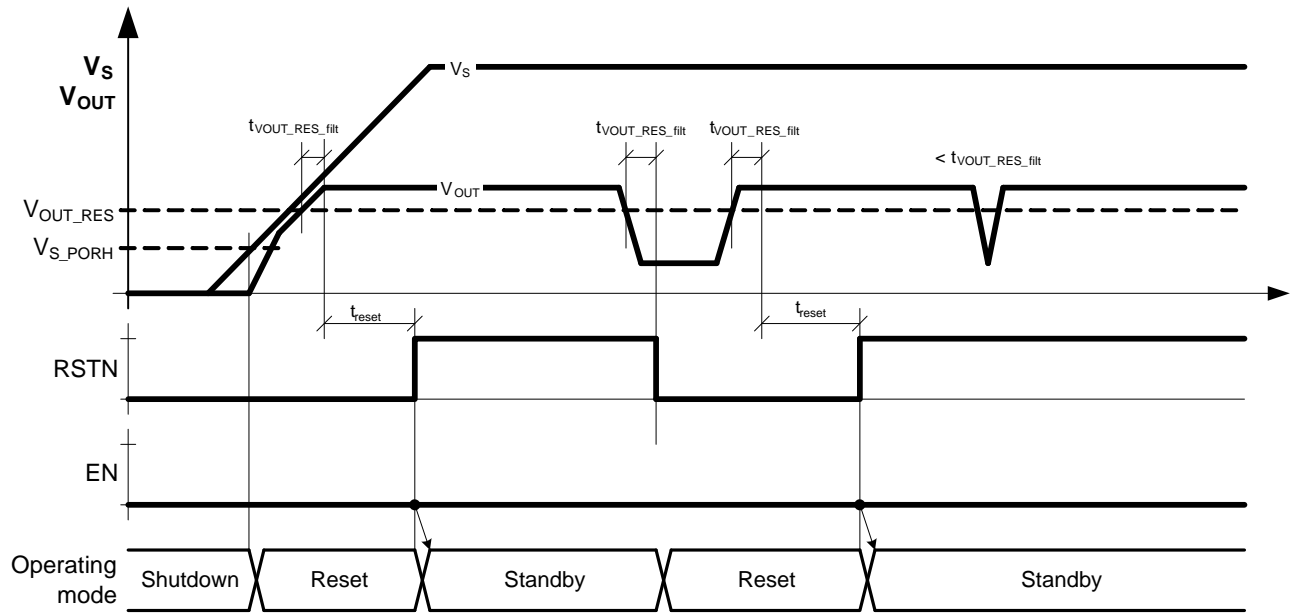
$V_{OUT}$  regulator is switched off, LIN transceiver is in the Wakeup mode.

If LIN wakeup is detected or EN goes High, Reset mode is entered. LIN wakeup is signaled by RxD, which remains Low until Normal mode is restored (EN is High).

### Thermal Shutdown

The device junction temperature is monitored in order to avoid permanent degradation or damage of the chip. Junction temperature exceeding the Shutdown level  $T_{J\_SD}$  puts the chip into Thermal Shutdown mode.

In Thermal Shutdown mode,  $V_{OUT}$  regulator is switched off. LIN transceiver is in Wakeup mode and can detect bus Wakeup. RxD pin stays pulled to  $V_{OUT}$  or is driven Low after valid Wakeup recognition. RSTN pin is pulled low. The mode is automatically left only when the junction cools down below the  $T_{J\_SD}$  threshold.



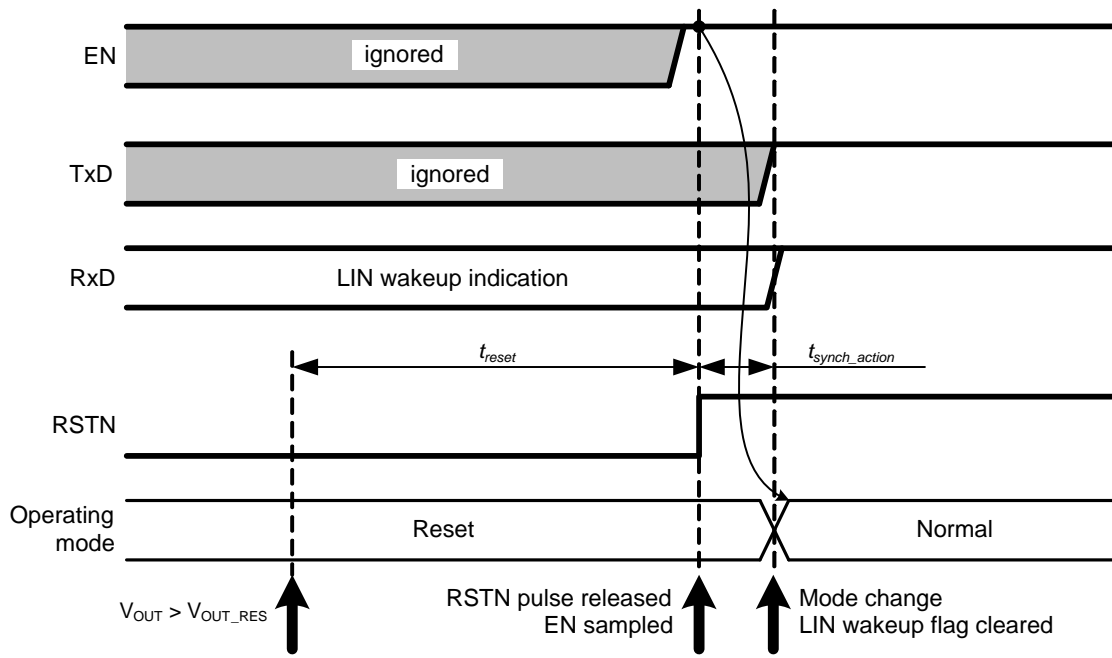


Figure 8. Operating Modes, Transition from Reset to Normal Mode

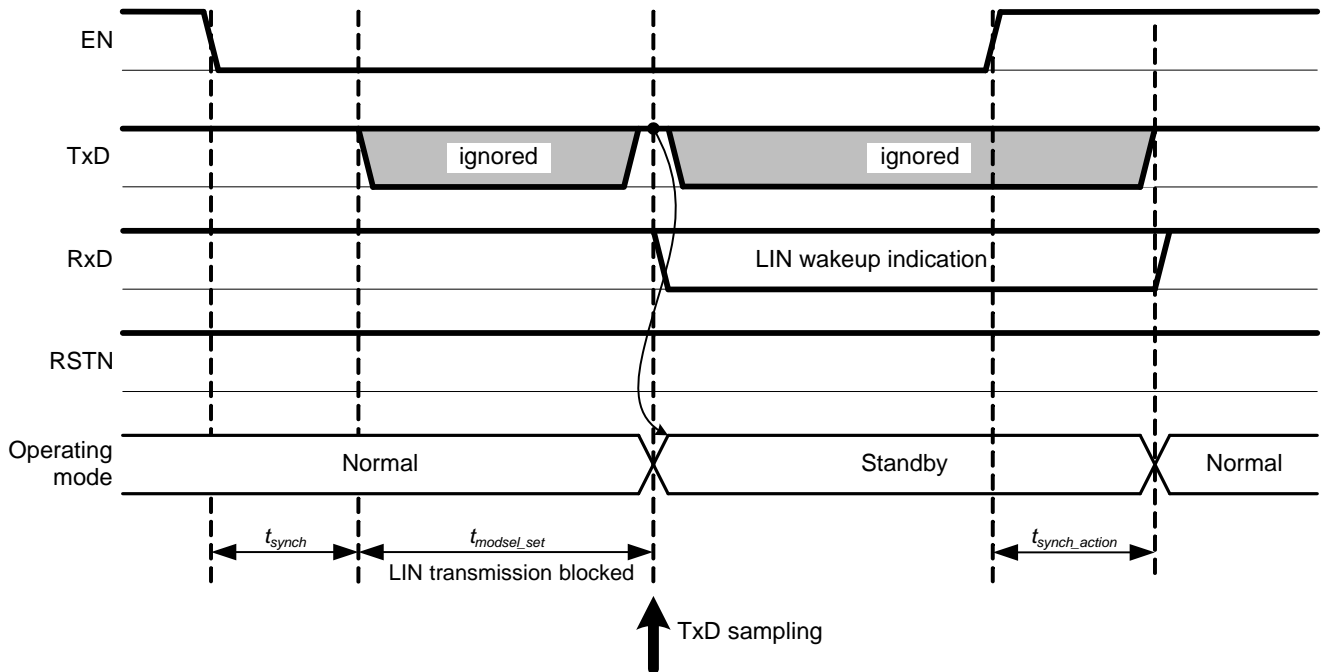


Figure 9. Operating Modes, Transition from Normal to Standby Mode

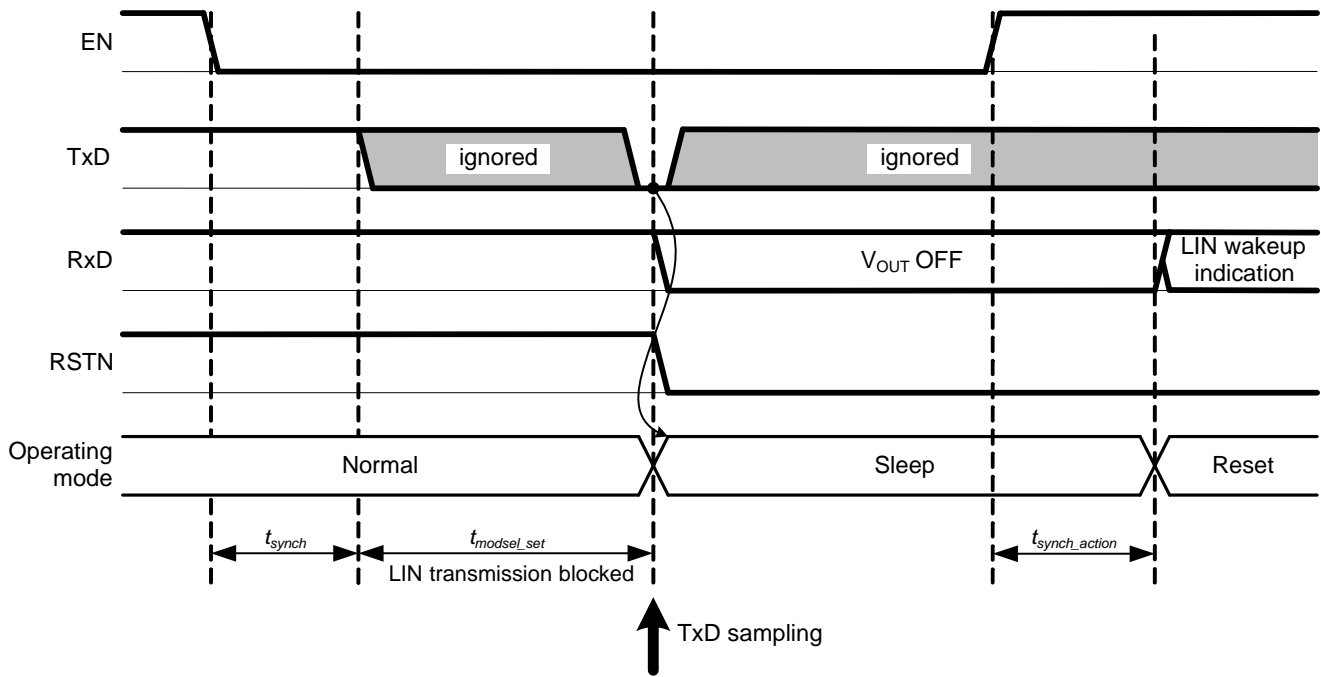


Figure 10. Operating Modes, Transition from Normal to Sleep Mode

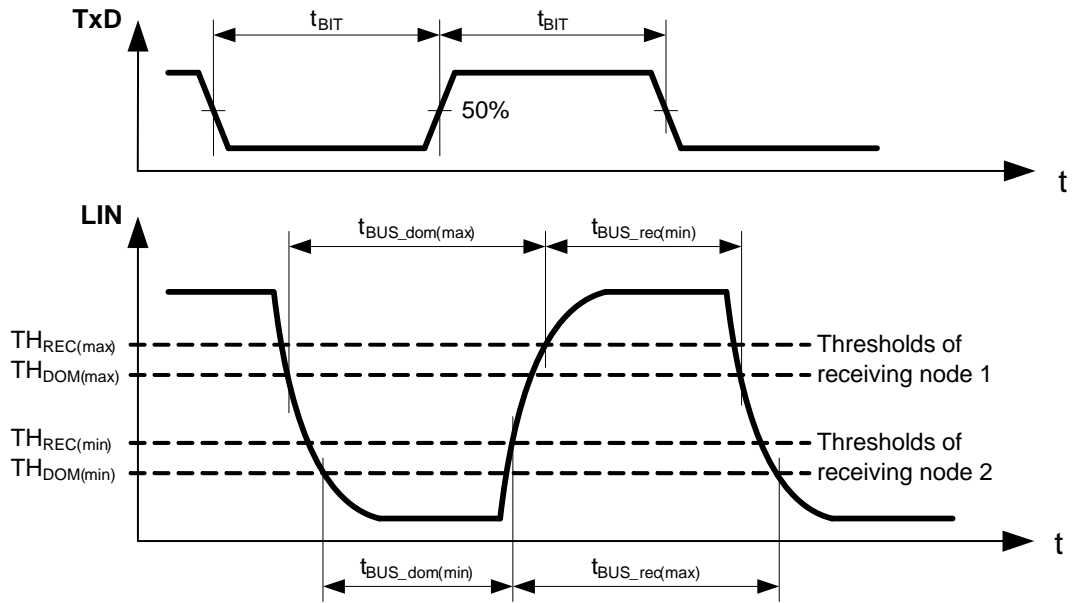


Figure 11. Definition of LIN Duty Cycle Parameters

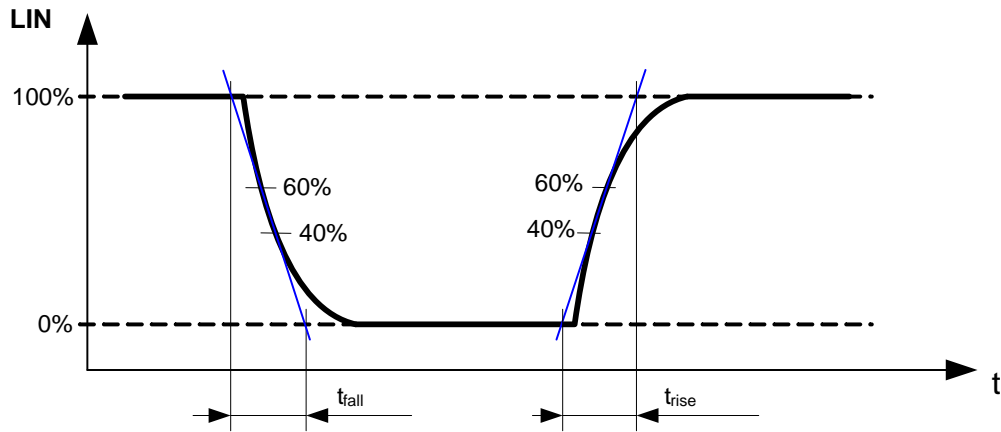


Figure 12. Definition of LIN Edge Parameters

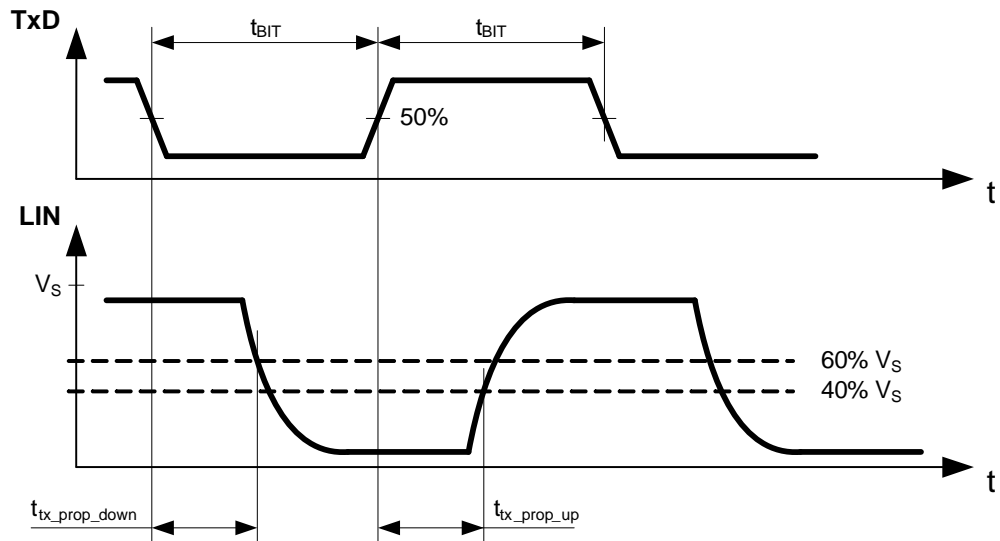


Figure 13. Definition of LIN Transmitter Timing Parameters

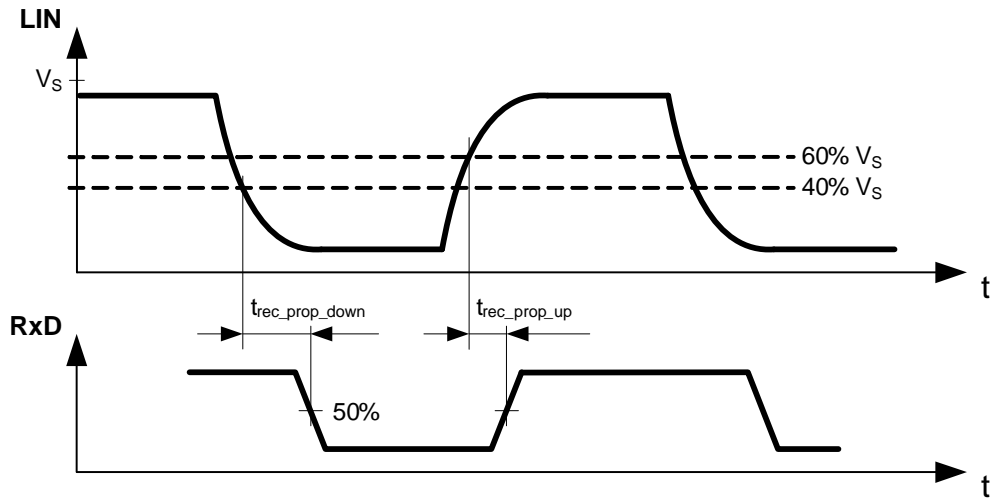


Figure 14. Definition of LIN Receiver Timing Parameters

# NCV7428

## ORDERING INFORMATION

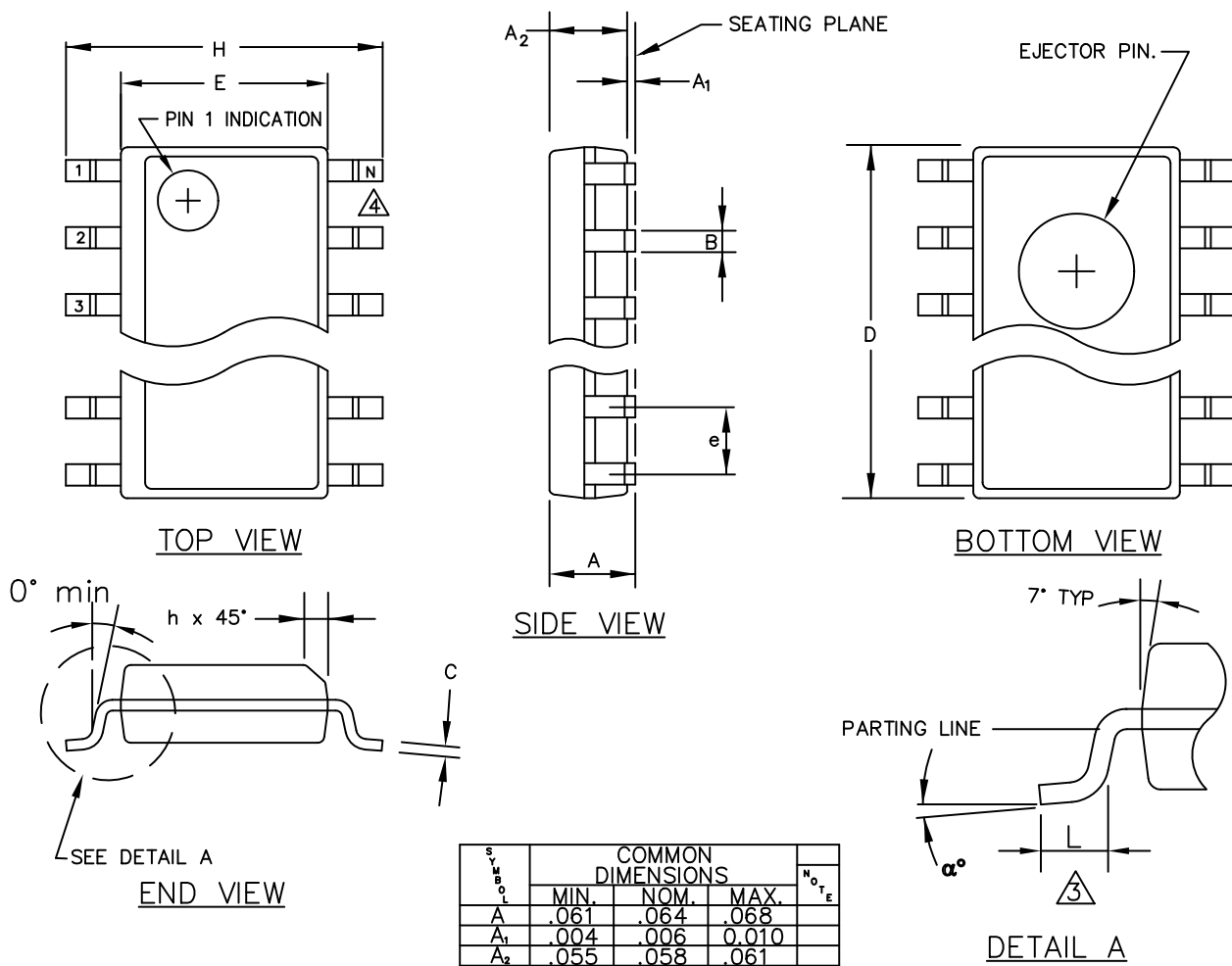
Part Number	Description	Marking	Package	Shipping †
NCV7428D15R2G	LIN transceiver with 5 V regulator	NV7428-5	SOIC-8 (Pb-Free)	3000 / Tape & Reel
NCV7428D13R2G	LIN transceiver with 3.3 V regulator	NV7428-3		
NCV7428D1L5R2G	LIN transceiver with 5 V regulator, low slope LIN	NV7428L5		
NCV7428D1L3R2G	LIN transceiver with 3.3 V regulator, low slope LIN	NV7428L3		
NCV7428MW5R2G (In Development)	LIN transceiver with 5 V regulator	NV7428-5	DFN8 (Pb-Free)	3000 / Tape & Reel
NCV7428MW3R2G (In Development)	LIN transceiver with 3.3 V regulator	NV7428-3		
NCV7428MWL5R2G (In Development)	LIN transceiver with 5 V regulator, low slope LIN	NV7428L5		
NCV7428MWL3R2G (In Development)	LIN transceiver with 3.3 V regulator, low slope LIN	NV7428L3		

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.



PACKAGE DIMENSIONS

SOIC 8  
CASE 751AZ  
ISSUE A



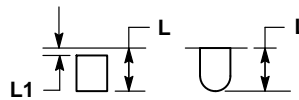
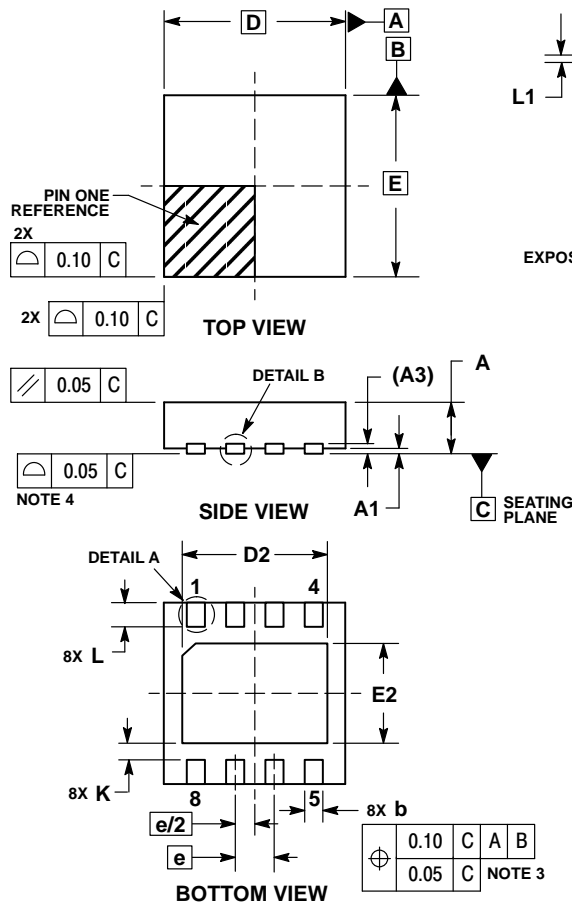
SYMBOL	COMMON DIMENSIONS			NOTE
	MIN.	NOM.	MAX.	
A	.061	.064	.068	
A <sub>1</sub>	.004	.006	.010	
A <sub>2</sub>	.055	.058	.061	
B	.0138	.016	.020	
C	.0075	.008	.0098	
D	SEE VARIATIONS			1
E	.150	.155	.157	
e	.050 BSC			
H	.230	.236	.244	
h	.010	.013	.016	
L	.016	.025	.035	
N	SEE VARIATIONS			2
α°	0°	5°	8°	

VARIATIONS				
1				2
D				N
NOTE	MIN.	NOM.	MAX.	
AA	.189	.194	.196	8
AB	.337	.342	.344	14
AC	.386	.391	.393	16

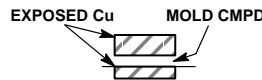
1. ALL DIMENSIONS ARE IN INCHES.

PACKAGE DIMENSIONS

DFN8, 3x3, 0.65P  
CASE 506BW  
ISSUE O



DETAIL A  
OPTIONAL  
CONSTRUCTIONS



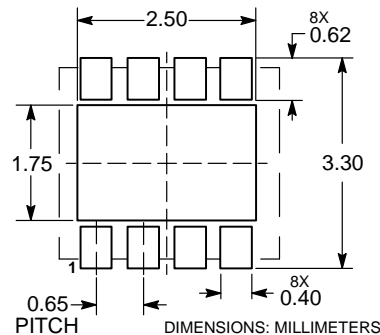
DETAIL B  
OPTIONAL  
CONSTRUCTIONS

NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30mm FROM THE TERMINAL TIP.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

DIM	MILLIMETERS	
	MIN	MAX
A	0.80	1.00
A1	0.00	0.05
A3	0.20	REF
b	0.25	0.35
D	3.00	BSC
D2	2.30	2.50
E	3.00	BSC
E2	1.55	1.75
e	0.65	BSC
K	0.20	---
L	0.35	0.45
L1	0.00	0.15

RECOMMENDED  
SOLDERING FOOTPRINT\*



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ON Semiconductor and are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of SCILLC's product/patent coverage may be accessed at [www.onsemi.com/site/pdf/Patent-Marketing.pdf](http://www.onsemi.com/site/pdf/Patent-Marketing.pdf). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor  
P.O. Box 5163, Denver, Colorado 80217 USA  
Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada  
Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada  
Email: [orderlit@onsemi.com](mailto:orderlit@onsemi.com)

N. American Technical Support: 800-282-9855 Toll Free  
USA/Canada  
Europe, Middle East and Africa Technical Support:  
Phone: 421 33 790 2910  
Japan Customer Focus Center  
Phone: 81-3-5817-1050

ON Semiconductor Website: [www.onsemi.com](http://www.onsemi.com)

Order Literature: <http://www.onsemi.com/orderlit>

For additional information, please contact your local Sales Representative

# AMEYA360

Components Supply Platform

Authorized Distribution Brand :



Website :

Welcome to visit [www.ameya360.com](http://www.ameya360.com)

Contact Us :

➤ Address :

401 Building No.5, JiuGe Business Center, Lane 2301, Yishan Rd  
Minhang District, Shanghai , China

➤ Sales :

Direct     +86 (21) 6401-6692  
  
Email        amall@ameya360.com  
  
QQ            800077892  
  
Skype        ameyasales1 ameyasales2

➤ Customer Service :

Email        service@ameya360.com

➤ Partnership :

Tel            +86 (21) 64016692-8333  
  
Email        mkt@ameya360.com